

Chip Inductors for Critical Applications ST336RAM

- Higher inductance values than ceramic 0805 inductors
- Heavy gauge wire for low DCR
- Ferrite construction for high current handling

Part number ¹	Inductance ² ±5% (μH)	Q min ³	Impedance typ (Ohms)	SRF min ⁴ (MHz)	DCR max ⁵ (Ohms)	I _{max} (mA)	Color code
ST336RAM111JRZ	0.11 @ 7.9 MHz	14 @ 7.9 MHz	370 @ 500 MHz	1000	0.05	700	Brown
ST336RAM681JRZ	0.68 @ 7.9 MHz	15 @ 7.9 MHz	430 @ 100 MHz	340	0.30	410	Orange
ST336RAM102JRZ	1.0 @ 7.9 MHz	13 @ 7.9 MHz	670 @ 100 MHz	280	0.39	360	Yellow
ST336RAM122JRZ	1.2 @ 7.9 MHz	15 @ 7.9 MHz	860 @ 100 MHz	300	0.64	260	Brown
ST336RAM152JRZ	1.5 @ 7.9 MHz	16 @ 7.9 MHz	1000 @ 100 MHz	225	0.74	250	Green
ST336RAM182JRZ	1.8 @ 7.9 MHz	16 @ 7.9 MHz	1360 @ 100 MHz	240	0.98	210	Blue
ST336RAM222JRZ	2.2 @ 7.9 MHz	15 @ 7.9 MHz	840 @ 50 MHz	90	0.98	190	Brown
ST336RAM272JRZ	2.7 @ 7.9 MHz	15 @ 7.9 MHz	1050 @ 50 MHz	80	1.16	190	Violet
ST336RAM332JRZ	3.3 @ 7.9 MHz	15 @ 7.9 MHz	1670 @ 50 MHz	65	1.20	190	Gray
ST336RAM472JRZ	4.7 @ 7.9 MHz	14 @ 7.9 MHz	950 @ 25 MHz	40	1.50	170	Black
ST336RAM682JRZ	6.8 @ 7.9 MHz	14 @ 7.9 MHz	450 @ 10 MHz	28	1.90	150	Brown
ST336RAM103JRZ	10 @ 2.5 MHz	14 @ 2.5 MHz	740 @ 10 MHz	18	2.20	130	Red
ST336RAM153JRZ	15 @ 2.5 MHz	13 @ 2.5 MHz	1300 @ 10 MHz	15	4.25	90	Yellow
ST336RAM223JRZ	22 @ 2.5 MHz	13 @ 2.5 MHz	1620 @ 10 MHz	15	6.70	75	Green

1. When ordering, please specify **termination** and **testing** codes:

ST336RAM223JRZ

Termination: R = RoHS compliant matte tin over nickel over silver-platinum-glass frit.

Special order:

Q = RoHS tin-silver-copper (95.5/4/0.5) over tin over nickel over silver-platinum-glass frit or

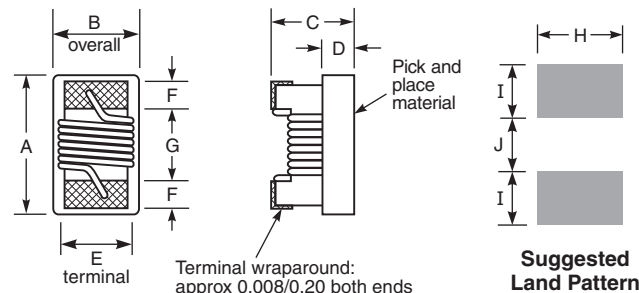
P = non-RoHS tin-lead (63/37) over tin over nickel over silver-platinum-glass frit.

Testing: Z = COTS

H = Screening per Coilcraft CP-SA-10001

- Inductance measured at 0.1 Vrms, using Coilcraft SMD-A fixture in Agilent/HP 4286A impedance analyzer or equivalent with Coilcraft-provided correlation pieces.
- Q measured on Agilent/HP 4291A with Agilent/HP 16197A test fixture or equivalents.
- SRF measured using Agilent/HP 8753ES network analyzer or equivalent with Coilcraft SMD-D test fixture.
- DCR measured on a Keithley 580 Micro-ohmmeter or equivalent with a Coilcraft CCF858 test fixture.
- Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.



A	B	C	D	E	F	G	H	I	J
max	max	max	ref						
0.090	0.068	0.060	0.020	0.050	0.016	0.040	0.070	0.040	0.030
2,29	1,73	1,52	0,51	1,27	0,41	1,02	1,78	1,02	0,76

Note: Dimensions are before optional solder application. For maximum overall dimensions including solder, add 0.0025 in / 0.064 mm to B and 0.006 in / 0.15 mm to A and C.

Core material Ferrite

Terminations RoHS compliant matte tin over nickel over silver-platinum-glass frit.

Weight 16.7–18.0 mg

Ambient temperature –40°C to +85°C with I_{max} current, +85°C to +100°C with derated current

Storage temperature Component: –55°C to +100°C.

Packaging: –55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

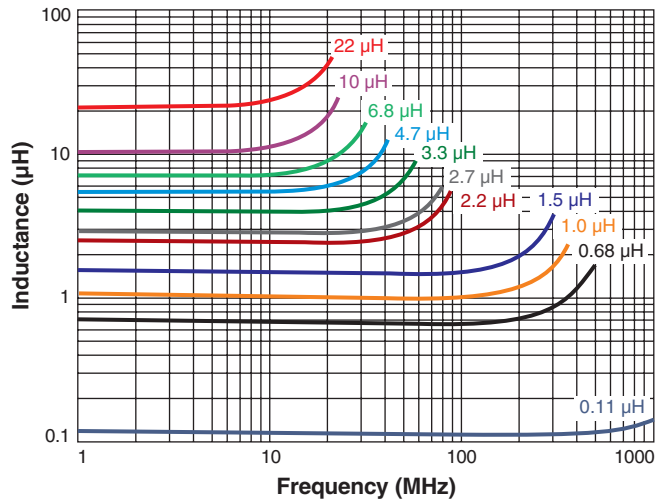
Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 2000/7" reel;

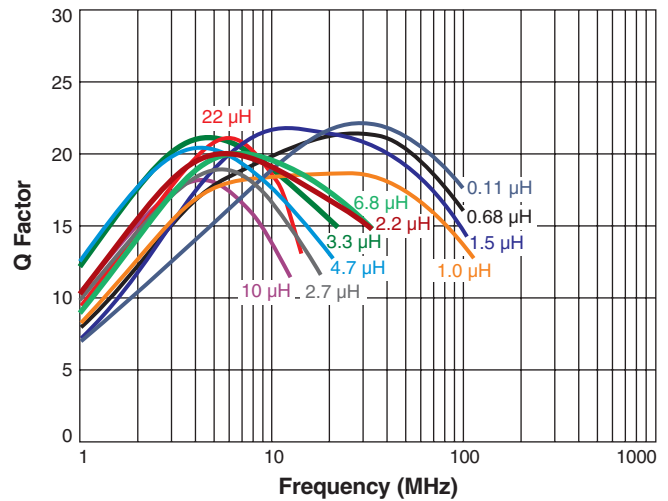
Plastic tape: 8 mm wide, 0.23 mm thick, 4 mm pocket spacing, 1.6 mm pocket depth

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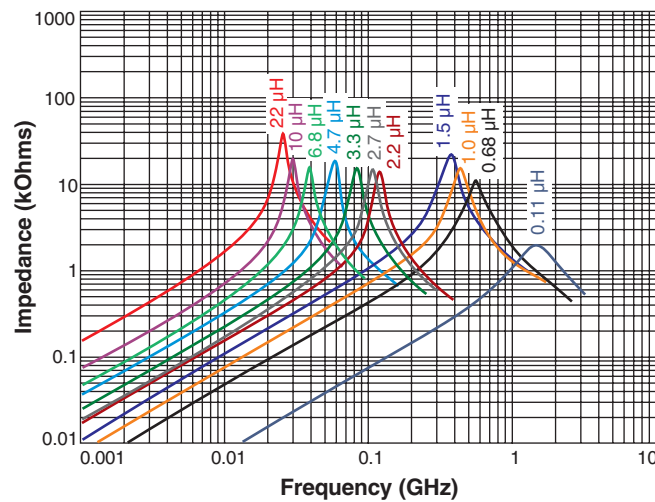
L vs Frequency



Q vs Frequency



Impedance vs Frequency



Imax Derating

